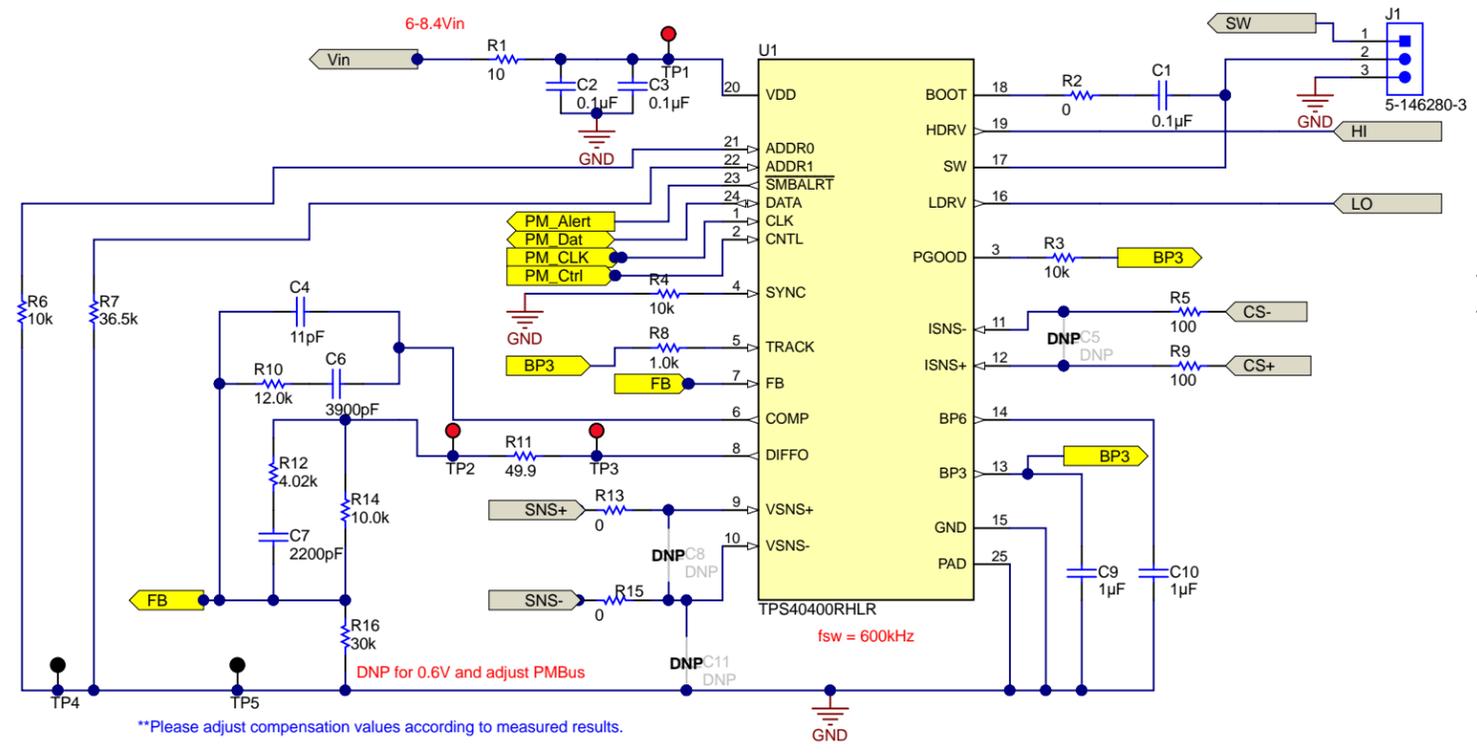


A

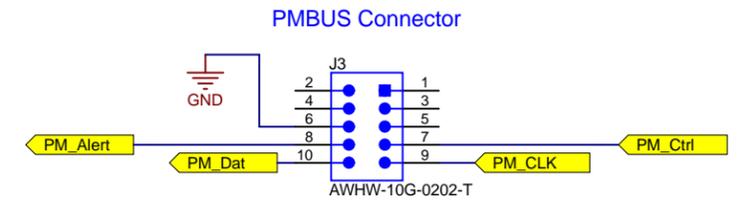
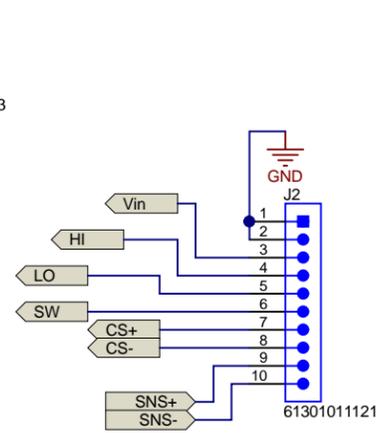
B

C

D



\*\*Please adjust compensation values according to measured results.



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TID #: N/A	Project Title: GaN Si control	
Number: PMP21440	Rev: A	Sheet Title:
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 1 of 1
Drawn By:	File: PMP21440 Control Board_BlankSheet.SchDoc	Size: B
Engineer: Jose Ramirez	Contact: <a href="http://www.ti.com/support">http://www.ti.com/support</a>	



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